INDUCTORS

公TDK

Inductors for power circuits **Multilayer ferrite** MLD series (for automotive)



AEC-Q200 MLD2012 type



FEATURES

O Being achieving high reliability by material application that was suitable for Automotive application and products design.

- O In complete monolithic structure with multilayer cluster, be reducing flux leakage
- Operating temperature range: -40 to +125°C (including self-temperature rise)

APPLICATION

O ADAS, car multimedia (telematics), various ECUs, various modules O Application guides: Car Infotainment

PART NUMBER CONSTRUCTION

MLD	2012	S	R47	Т	Т	D25
Series name	L x W dimensions 2.0×1.25 mm	Characteristic type	Inductance (µH)	Height (mm max.)	Packaging style	Internal code

CHARACTERISTICS SPECIFICATION TABLE

Thickness	L		Measuring frequency	DC resistance	Rated current*	Part No.
т					Itemp	
(mm)max.	(µH)	Tolerance	(MHz)	(Ω)	(mA)max.	
0.55	0.47	±20%	2	0.120±30%	1200	MLD2012SR47TTD25

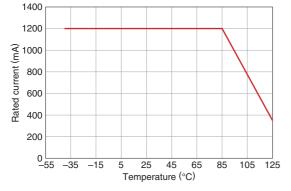
*Rated current(Itemp): current assumed when temperature has risen to 40°C max.

*Please refer to the graph of rated current vs. temperature characteristics (derating) about the rating current at 85°C or more in temperature of the product.

Measurement equipment

Measurement item	Product No.	Manufacturer	
L	4294A	Keysight Technologies	
DC resistance	Digital Milliohm Meter		
Rated current Isat	4285A+42841A+42842C	Keysight Technologies	
* Equivalent measurement equipment may be used.			

O Rated current vs. temperature characteristics (derating)



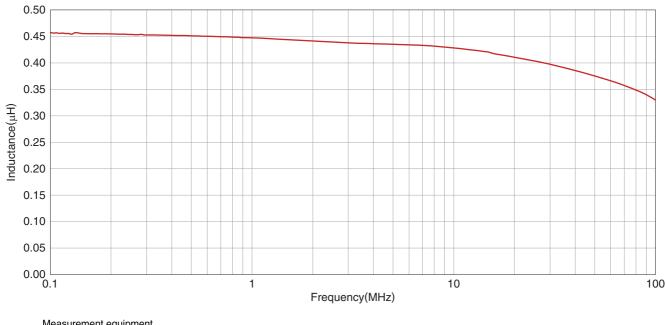


Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading. (1/4)

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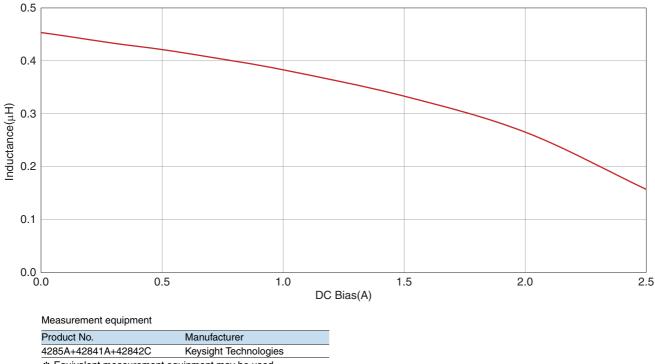
MLD2012 type

L FREQUENCY CHARACTERISTICS



Measurement equipment			
Product No.	Manufacturer		
4294A	Keysight Technologies		
* Equivalent measurement equipment may be used.			

■ INDUCTANCE VS. DC BIAS CHARACTERISTICS

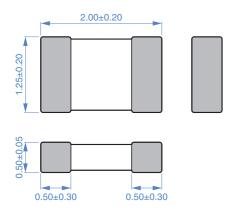


* Equivalent measurement equipment may be used.

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MLD2012 type

SHAPE & DIMENSIONS



RECOMMENDED LAND PATTERN

0.80

Dimensions in mm

RECOMMENDED REFLOW PROFILE

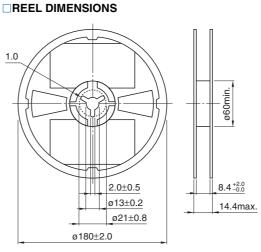
0.80

1.00

Dimensions in mm

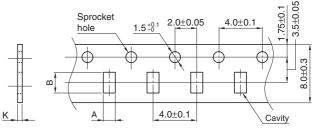
2

PACKAGING STYLE



Dimensions in mm

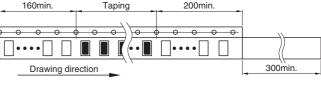
TAPE DIMENSIONS



Dimensions in mm

Туре	А	В	К
MLD2012	1.60±0.10	2.40±0.10	0.75±0.10

Carrier tape material: Polystyrene Cover tape material: Polystyrene



Dimensions in mm

PACKAGE QUANTITY

Package quantity

4000 pcs/reel

TEMPERATURE RANGE, INDIVIDUAL WEIGHT

Operating temperature range*	Storage temperature range**	Individual weight
–40 to +125 °C	–40 to +125°C	7 mg
* Operating temperature range includes self-temperature rise.		

** The storage temperature range is for after the assembly.

Preheating Soldering Natural cooling Peak 250 to 260°C Temperature 230°

230°C 180°C 10s max. 150°C 60 to 120s 30 to 60s Time

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REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using this products.

The storage period is less than 12 months. Be sure to follow the storage conditions (temperature: 5 to 40°C, humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.					
Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).					
	Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.				
Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.					
	When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.				
Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.					
 Carefully lay out the coil for the circuit board design of the non-ma A malfunction may occur due to magnetic interference. 	 Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. 				
\bigcirc Use a wrist band to discharge static electricity in your body throug	h the grounding wire.				
\bigcirc Do not expose the products to magnets or magnetic fields.					
O Do not use for a purpose outside of the contents regulated in the	lelivery specifications.				
ment, industrial robots) under a normal operation and use condition The products are not designed or warranted to meet the requirement ity require a more stringent level of safety or reliability, or whose far person or property.	ment, personal equipment, office equipment, measurement equip- on. ents of the applications listed below, whose performance and/or qual- allure, malfunction or trouble could cause serious damage to society,				
If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us.					
 (1) Aerospace/aviation equipment (2) Transportation equipment (electric trains, ships, etc.) (3) Medical equipment (4) Power-generation control equipment (5) Atomic energy-related equipment (6) Seabed equipment (7) Transportation control equipment 	 (8) Public information-processing equipment (9) Military equipment (10) Electric heating apparatus, burning equipment (11) Disaster prevention/crime prevention equipment (12) Safety equipment (13) Other applications that are not considered general-purpose applications 				
When designing your equipment even for general-purpose applicatio tection circuit/device or providing backup circuits in your equipment.	ns, you are kindly requested to take into consideration securing pro-				

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. (4/4) Please note that the contents may change without any prior notice due to reasons such as upgrading.